RICOH

6 A Low ON Resistance Nch Load Switch IC with Voltage Detector

NO.EA-335-181030

OUTLINE

The R5542Z is a Nch. load switch IC with a voltage detector. The R5542Z is an ideal load switch IC for supplying the power from the battery to the load circuit. A built-in Nch. driver transistor with typically 9 m Ω ON resistance allows the R5542Z to provide a low dropout voltage and prevents the reverse current during shutdown mode. Internally, the R5542Z consists of an internal voltage step-up circuit, a soft-start circuit, a chip enable circuit and a UVLO circuit.

The R5542Z is offered in an ultra-small WLCSP-12-P3 package which can achieve the smallest possible footprint solution on boards where area is limited.

FEATURES

Load Switch Section

- Input Voltage Range ······ 2.3 V to 5.5 V
- Output Current DC Max. 6 A
- Output Pulsed Current Max. 12 A (Pulsed at 1 ms, 10% Duty Cyce)
- Switch ON Resistance \cdots 9 m Ω (V_{IN} = 3.0 V, I_{OUT} = 300 mA)
- Reverse Current Blocking (RCB) during shutdown mode
- Soft-start Function

Voltage Detector Section

- Supply Current...... Typ. 1.0 μA (V_{VDI} = 2.0 V)
- Detector Threshold Range------ 2.0 V to 5.0 V (0.1 V steps)
- Detector Threshold Accuracy ±2.0%
- Detector Threshold Temperature Coefficient Typ. ±100 ppm/°C
- Output Type ······ CMOS
- Package ······ WLCSP-12-P3

APPLICATIONS

- Smart Phones, Tablet PCs
- Storage, Portable Devices

NO.EA-335-181030

SELECTION GUIDE

The detector threshold is a user-selectable option.

Selection Guide

| Product Name | Package | Quantity per Reel | Pb Free | Halogen Free |
|-----------------|-------------|-------------------|---------|--------------|
| R5542Zxx2B-E2-F | WLCSP-12-P3 | 4,000 pcs | Yes | Yes |

xx: Specify the detector threshold within the range of 2.0 V (20) to 5.0 V (50) in 0.1 V steps.

BLOCK DIAGRAMS



R5542Zxx2B Block Diagram

NO.EA-335-181030

PIN DESCRIPTIONS



R5542Z (WLCSP-12-P3) Pin Configurations

R5542Z Pin Descriptions

| Pin No. | Symbol | Pin Description | |
|----------------|--------|--------------------------------|--|
| A1, B1, B2, C1 | OUT | Load Switch Output Pin | |
| A3, B3, C2, C3 | IN | Load Switch Input Pin | |
| A2 | LCE | Load Switch Control Enable Pin | |
| D1 | GND | Ground Pin | |
| D2 | VDO | Voltage Detector Output Pin | |
| D3 | VDI | Voltage Detector Input Pin | |

NO.EA-335-181030

ABSOLUTE MAXIMUM RATINGS

Absolute Maximum Ratings

| Symbol | Item | Rating | Unit |
|------------------|--|-------------------------------|------|
| V _{IN} | Load Switch Input Voltage | -0.3 to 6.0 | V |
| Vout | Load Switch Output Voltage | –0.3 to V _{IN} + 0.3 | V |
| VLCE | L _{CE} Pin Voltage | -0.3 to 6.0 | V |
| Vvdi | VDI Pin Voltage | -0.3 to 6.0 | V |
| V _{VDO} | VDO Pin Voltage | -0.3 to V _{VDI} +0.3 | V |
| VPP | Pin to Pin Voltage | -0.3 to 6.0 | V |
| I _{OUT} | Load Switch Output Current | 6.0 | А |
| IPULSE | Load Switch Output Pulsed Current (Pulsed at 1ms, 10% Duty Cycle) | 12.0 | A |
| PD | Power Dissipation ⁽¹⁾ (WLCSP-12-P3, JEDEC STD.51-9) | 1000 | mW |
| Tj | Junction Temperature Range | -40 to 125 | °C |
| Tstg | Storage Temperature Range | -55 to 125 | °C |

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings are not assured.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Item | Rating | Unit |
|--------|-----------------------------|------------|------|
| Vin | Input Voltage | 2.3 to 5.5 | V |
| Ta | Operating Temperature Range | -40 to 85 | °C |

RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

⁽¹⁾ Refer to POWER DISSIPATION in SUPPLEMENTSRY ITEMS for detail information.

4

NO.EA-335-181030

ELECTRICAL CHARACTERISTICS

 $V_{IN} = 2.3 \text{ V}$ to 5.5 V, $I_{OUT} = 1 \text{ mA}$, $C_{IN} = 1 \mu F$, $C_{OUT} = \text{None}$, unless otherwise noted. The specifications surrounded by are guaranteed by design engineering at $-40^{\circ}\text{C} \le \text{Ta} \le 85^{\circ}\text{C}$.

| Electrical Characteristics (Ta = 25°C) | | | | | | | |
|--|---|--|--|-----------------------------|----------------------------|-----------------------------|------------|
| Symbol | Item Conditions | | Min. | Тур. | Max. | Unit | |
| Load S | witch Section | | | | | | |
| la | Quiescent Current | Iout = 0 mA | | | 10 | 30 | μA |
| IQ(OFF) | Standby Current | $V_{LCE} = 0 V, V_{I}$ | N = 5.5 V, Vout =OPEN | | | 1 | μA |
| Isd | Shutdown Current | $V_{LCE} = 0 V, V_{I}$ | м= 5.5 V, Vout =GND | | | 1 | μA |
| Ron | Switch ON Resistance | louт = 300 m/ | A, V _{IN} = 3 V | | 9 | | mΩ |
| VIH | LCE Pin Input Voltage, high | $V_{IN} = 5.0 V$ | | 1.0 | | | V |
| VIL | LCE Pin Input Voltage, low | $V_{IN} = 5.0 V$ | | | | 0.4 | V |
| RLCE_PD | LCE Pull-down Resistance | $V_{IN} = 2.3 \text{ V to}$ | 5.5 V | | 5.5 | | MΩ |
| ILCE | LCE Input Leakage Current | $V_{IN} = 2.3 \text{ V to}$ | 5.5 V, V _{LCE} = GND | -1 | | 1 | μA |
| ton | Turn-on Time | $V_{IN} = 3 V, R_L$ | = 50 Ω, Cout = 10 μF | | 2 | | ms |
| UVLO | Undervoltage Lockout Voltage ⁽¹⁾ | | | 2.0 | | 2.3 | V |
| Voltage | Detector Section | | | | | | |
| -Vdet | Detector Threshold ⁽²⁾ | V _{VDI} falling | | -V _{SET} х 0.98 | | -V _{SET} х 1.02 | V |
| V _{HYS} | Detector Threshold Hysteresis | | | -V _{SET} x0.03 | -V _{SET} х0.05 | -V _{SET} х0.07 | V |
| | | 2.0V < -V _{SET} , V _{VDI} = 2.0V | | | 1.0 | | |
| Iss | Supply Current | 2.0V ≤ -V _{SET} | $V_{VDI} = -V_{SET} - 0.16V$ | | | 3.3 | μA |
| | | ≤ 5.0V V _{VDI} | $V_{VDI} = -V_{SET} + 0.50V$ | | | 3.4 | 1 |
| | Voltage Detector Operating | Ta = 25°C | | 1.2(3) | | 5.5 | |
| VVDI | Voltage | -40°C ≤ Ta ≤ 85°C | | 1.3(3) | | 5.5 | ۲ [|
| Ivdo | Output Current (Nch. Driver Output Pin) | 2.0 ≤ -V _{SET} | V _{DS} = 0.5 V, V _{VDI} = 1.5 V | 1.0 | 2.0 | | |
| | Output Current (Pch. Driver Output Pin) | ≤ 5.0 V | $V_{DS} = -2.1 V,$ $V_{VDI} = 5.5 V,$ | 1.0 | 2.5 | | |
| t _{PLH} | Release Output Delay Time ⁽⁴⁾ | | | | | 100 | μs |
| Δ-V _{DET} /ΔTa | Detector Threshold Temperature Coefficient | -40°C ≤ Ta ≤ 85°C | | | ±100 | | ppm /°C |

All test items listed under Electrical Characteristics are done under the pulse load condition (Tj \approx Ta = 25°C) except Detector Threshold Temperature Coefficient.

⁽¹⁾ The UVLO detector threshold and the UVLO release voltage are between the min and max of UVLO with Typ. 0.02 V hysteresis.

⁽²⁾ –V_{DET} is defined as an actual detector threshold and –V_{SET} is defined as a preset detector threshold.

⁽³⁾ Each minimum value is the value of input voltage when the output voltage is maintained at 0.1 V or less.

⁽⁴⁾ Refer to *"Release Output Delay Time"* for details.

NO.EA-335-181030

OPERATING DESCRIPTIONS

Voltage Detector Section



R5542Zxx2B Block Diagram



Operation Diagram

- 1. The V_{VDO} voltage is equalized to the V_{VDI} voltage.
- The V_{VDI} voltage drops to the detector threshold (A point) which means Vref ≥ V_{VDI} x (Rb+Rc) / (Ra+Rb+Rc). The comparator output shifts from "L" to "H" voltage and the VDO pin voltage will be equalized to the GND voltage.
- 3. If the V_{VDI} voltage is lower than the minimum operating voltage, the V_{VDO} voltage becomes unstable.
- 4. The VDO pin voltage is equalized to the GND voltage.
- 5. The V_{VDI} voltage becomes higher than the release voltage (B point) which means Vref < V_{VDI} x Rb / (Ra+Rb), and the comparator output shifts from "H" to "L" voltage, and the VDO pin voltage is equalized to the V_{VDI} voltage.

Note: The difference between a released voltage and a detector threshold voltage is a detector threshold hysteresis.

NO.EA-335-181030

Timing Chart



R5542Zxx2B Voltage Detector Section

Release Output Delay Time (t_{PLH})

Release output delay time starts when the V_{VDI} voltage is shifted from 1.3V to + V_{DET} + 1.0V and ends when the output voltage reaches (+ V_{DET} + 1.0V) / 2.



R5542Zxx2B Release Output Delay Time

NO.EA-335-181030

APPLICATION INFORMAITON

Typical Application Circuit



R5542Zxx2B Typical Application Circuit

TECHNICAL NOTES

The R5542Z does not require any bypass capacitor between IN and GND. However connecting 1µF or more capacitor between IN and GND may improve the performance against noise. To make delay time from detect input voltage drop to load switch turn off, connect resistor and capacitor between VDO and LCE.

If the ramp rate of "IN" is faster than $50 \text{mV}/\mu s$, some voltage glitch may appear on "OUT". The glitch level depends on the capacitance connected to "OUT" and the ramp rate of "IN".

NO.EA-335-181030

TYPICAL CHARACTERISTICS

Typical Characteristics are intended to be used as reference data, they are not guaranteed.

1) ON Resistance vs. Temperature / Input Voltage













 R_{LOAD} = 10 Ω / C_{OUT} = none / Ta = 25 $^\circ\!\mathrm{C}$





NO.EA-335-181030

4) SW Standby Current vs. Temperature / Input Voltage



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RICOH





7) VIL vs. Temperature / Input Voltage

1

0.9

0.8 0.7

0.9 0.8 0.7 VIL [V] 0.6 0.5 0.4 0.3



9) UVLO Detection/Release Voltage vs. Temperature

R5542Z

NO.EA-335-181030

NO.EA-335-181030

11) V_{HYS} vs. Temperature



NO.EA-335-181030





NO.EA-335-181030



Соит = 10µF

















NO.EA-335-181030

19) VD-SW Reset



 $V_{\text{IN}}\,{=}\,V_{\text{DI}}\,{=}\,3.8\,V$ ${<}{-}{>}\,2.8\,V$ / C1 = $0.01\mu F$

 $V_{IN} = V_{DI} = 3.8V <-> 2.8V / C1 = 1.0\mu F$



NO.EA-335-181030



VDI Input Voltage [V]

20) VD Supply Current vs. Input Voltage $V_{DI}=0~V\rightarrow 6.0~V$

VDI Input Voltage [V]

POWER DISSIPATION

WLCSP-12-P3

Ver. B

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following conditions are used in this measurement.

Measurement Conditions

| | JEDEC STD. 51-9 Test Land Pattern | |
|---|--|--|
| Environment Mounting on Board (Wind Velocity = 0 m/s) | | |
| Board Material | Glass Cloth Epoxy Plastic (Four-Layer Board) | |
| Board Dimensions | 101.5 mm x 114.5 mm x 1.6 mm | |
| Copper Ratio | Outer Layers (First and Fourth Layers): Approx. 60% | |
| | Inner Layers (Second and Third Layers): Approx. 100% | |

Measurement Result

(Ta = 25°C, Tjmax = 125°C)

| | JEDEC STD. 51-9 Test Land Pattern | |
|--------------------|---------------------------------------|--|
| Power Dissipation | 1000 mW | |
| Thermal Resistance | θja = (125 - 25°C) / 1.0 W = 100 °C/W | |





Power Dissipation vs. Ambient Temperature

IC Mount Area (mm)
Measurement Board Pattern

PACKAGE DIMENSIONS

WLCSP-12-P3

Ver. B



WLCSP-12-P3 Package Dimensions (Unit: mm)

RICOH

WLCSP

VI-160823

| No. | Inspection Items | Inspection Criteria | Figure |
|-----|-------------------------------|---|----------|
| 1 | Package chipping | A≥0.2mm is rejected B≥0.2mm is rejected C≥0.2mm is rejected And, Package chipping to Si surface and to bump is rejected. | B ↓ C |
| 2 | Si surface chipping | A≥0.2mm is rejected B≥0.2mm is rejected C≥0.2mm is rejected But, even if A≥0.2mm, B≤0.1mm is acceptable. | B t C |
| 3 | No bump | No bump is rejected. | |
| 4 | Marking miss | To reject incorrect marking, such as another product name marking or another lot No. marking. | |
| 5 | No marking | To reject no marking on the package. | |
| 6 | Reverse direction of marking | To reject reverse direction of marking character. | |
| 7 | Defective marking | To reject unreadable marking. (Microscope: X15/ White LED/ Viewed from vertical direction) | |
| 8 | Scratch | To reject unreadable marking character by scratch. (Microscope: X15/ White LED/ Viewed from vertical direction) | |
| 9 | Stain and Foreign material | To reject unreadable marking character by stain and foreign material. (Microscope: X15/ White LED/ Viewed from vertical direction) | |

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